

Lecture 16 - Soldering

- Layout: Proto board set up much like bread board
Best to put components, wires on one side,
solder on other.
→ So you can see everything
- IC sockets: Hard to remove soldered chip
Better to use socket:
solder socket to board
add/remove chip as needed
- Wires: Two types: solid & stranded
Best to use solid wire for on-board connections
(easier)
Use stranded for off-board connections
(flexible)

I like using strips from ribbon cable:
Good for groups of off-board wire that
go to same place
- Cutting & Stripping: use stripper tool
Don't make on-board wires too long:
hard to deal with big loops

Leave 6+'' leads for off-board wires

Soldering

Solder component pins to pads on board

Solder = tin-lead alloy, melts at $\sim 200^{\circ}\text{C}$

Newer solders lead-free, don't work as well

Also contains flux: cleaning agent, makes smoke, smell

Technique:

Heat up pad & pin with soldering iron

Works best if iron already "wetted" with a little solder

Apply more to joint (not to iron!)

Apply enough solder to fill in hole

- avoid large blobs

Don't eat the solder. Also, smoke from flux can be irritating,
& iron will burn you

Solder Removal:

Use solder wick

Place over solder, heat with iron

Works best with fresh wick

Schedule:

- Do testing worksheet today, turn in
- Start soldering work: due 11/12